



# Product Change Notification

**Change Notification #:** 116356 - 00  
**Change Title:** Intel® Material Master ID (MMID) Number Conversion, PCN 116356-00, Documentation, Order Code, MMID Conversion  
**Date of Publication:** August 3, 2018

## Key Characteristics of the Change:

Documentation, Order Code

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	September 5, 2018
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## Description of Change to the Customer:

Starting September 5, 2018, Intel is changing the Finished Goods Material Master ID (MMID, MM#) for Intel Products from 6 digit numeric to 6 character alphanumeric, and leading zeroes (if provided) will be eliminated (i.e. Current: 00000000000999123 or 999123 to Future: 999FC2). Existing Finished Goods Material Master IDs will remain 6 digit numeric with leading zeroes (if provided) and will not be modified. Only new MMIDs created after September 5, 2018 will reflect the alphanumeric change.

## Customer Impact of Change and Recommended Action:

Business systems and processes (i.e. ordering, invoicing, labeling, scanning) that reference Intel's Finished Good Material Master ID must ensure code will handle the introduction of alphanumeric MMIDs and the removal of leading zeroes by September 5, 2018.

Intel encourages customers to understand the change and determine the impact on their applications.

Please contact your Intel Account Representative/Customer Business Analyst if you have any further questions about this change.

## PCN Revision History:

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
August 3, 2018	00	Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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